

SPECIFICATION FOR TFT MODULE

MODULE NO: AFS240320TG-2.4-P150001 REVISION NO: 00

Customer's Approval:

	SIGNATURE	DATE
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1. Features & Mechanical Specifications

Item	Contents LCD	Unit
LCD Туре	TFT / Transmissive / Normal White	
Viewing direction	12 O'clock	
Backlight	4 Chip White LED in Parallel	
Interface	3-wine SPI+RGB interface	
Driver IC	ILI9341	
Outline Dimension	$42.72(W) \times 60.26(H) \times 2.4(T)$	mm
Glass area (W×H×T)	39.72 ×55.76 × 1.0	mm
Active area (W×H)	36.72 × 48.96	mm
Number of Dots	240(RGB) × 320	
Dot pitch (W×H)	0.051 × 0.153	mm
Pixel pitch (W×H)	0.153 × 0.153	mm
Operating Temperature	$-20 \sim +70$	°C
Storage temperature	$-30 \sim +80$	°C

2. Dimensional Outline

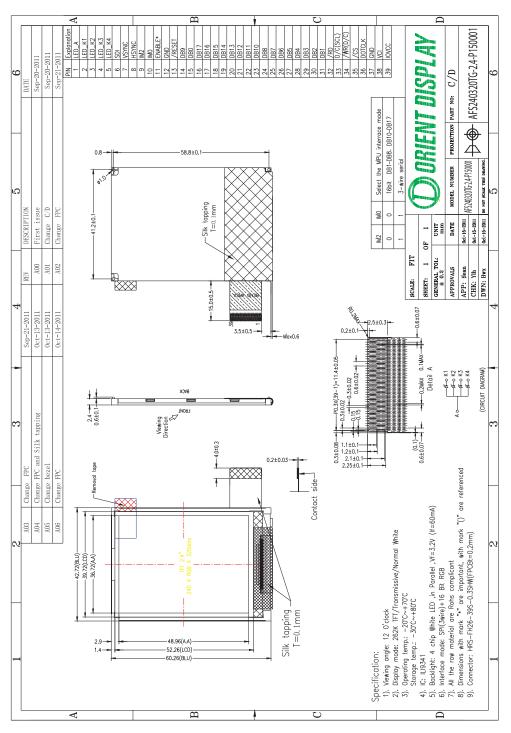


Figure 1. Dimensional outline

2. Block Diagram

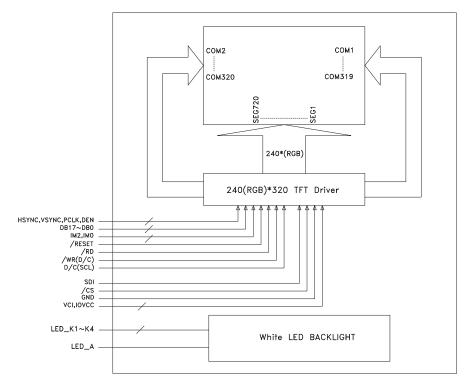


Figure 2. Block diagram

4. Pin Description

	SYMPOT	Exaction
PIN No.	SYMBOL	Function
1	LED_A	Backlight LED Anode
2	LED_K1	Backlight LED1 Cathode
3	LED_K2	Backlight LED2 Cathode
4	LED_K3	Backlight LED3 Cathode
5	LED_K4	Backlight LED4 Cathode
6	SDI	The data is applied on the rising edge of the SCL signal. If not used, fix this pin GND.
7	VSYNC	Frame synchronizing signal for RGB interface operation Fix to GND level when not in use.
8	HSYNC	Line synchronizing signal for RGB interface operation. Fix to GND level when not in use.
9	IM2	Select the system interface mode. Please See "Interface Note"
10	IM0	Select the system interface mode. Please See "Interface Note"
11	ENABLE	Data enable signal for RGB interface operation. Fix to GND level when not in use.
12	GND	Ground
13	/RESET	Reset pin. (Active Low)
14	DB9	Data Bus
15	DB0	Data Bus
16~23	DB17~DB10	Data Bus
24~31	DB8~DB1	Data Bus
32	/RD	- 8080 system (/RD) Serves as a read signal and MCU read data at the rising edge. Fix to IOVCC level when not in use.
33	D/C(SCL)	This pin is used to select "Data or Command" in the parallel interface or 4-wire 8- bit serial data interface. When $D/C = '1'$, data is selected. When $D/C = '0'$, command is selected. This pin is used serial interface clock in 3-wire 9-bit / 4-wire 8-bit serial data interface. If not used, this pin should be connected to IOVCC or GND.
34	/WR(D/C)	 - 8080 system (/WR): Serves as a write signal and writes data at the rising edge. - 4-line system (D/C): Serves as command or parameter select. Fix to IOVCC level when not in use.
35	/CS	Chip selection pin (Low enable)
36	DOTCLK	Dot clock signal for RGB interface operation Fix to GND level when not in use.
37	GND	Ground
38	VCI	High voltage power supply for analog circuit blocks (2.8 V)
39	IOVCC	Low voltage power supply for interface logic circuits $(1.8 / 2.8 V)$

Interface Note:

IM2	IM0	Interface Mode
0	0	8080-16bit interface: DB17~DB10, DB8~DB1
0	1	8080-8bit interface: DB17~DB10
1	1	9-bit 3 wires Serial Peripheral interface
1	0	8-bit 4 wires Serial Peripheral interface

R 1	R2	Interface Mode
Open	Short	9-bit 3 wires Serial Peripheral interface (default)
Short	Open	8-bit 4 wires Serial Peripheral interface

R1, R2 are SMT Components on the FPC.

5. Absolute Maximum Ratings

Item	Symbol	Rating	Unit
Supply Voltage range	VCI	-0.3 to +4.6	V
Supply Voltage range	IOVCC	-0.3 to +4.6	V
Operating Temperature range	TOP	-20 to +70	°C
Storage Temperature range	TST	-30 to +80	°C

<u>6. Electrical Characteristics</u>

DC Characteristics

Item	Symbol	Min.	Type.	Max.	Unit
Logic Supply Voltage	VCI	2.5	2.8	3.3	V
I/O Supply Voltage	IOVCC	1.65	2.8	3.3	V

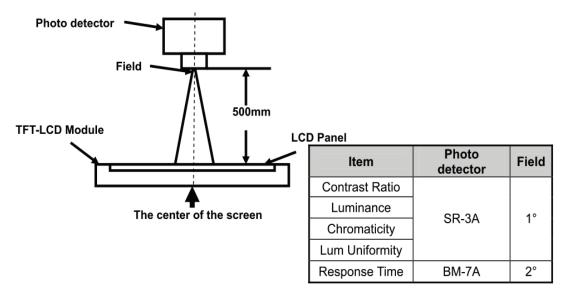
7. Backlight Characteristics

White LED \times 4 Parallel						$(Ta = 25^{\circ}C)$
Item	Symbol	Condition	Min	Тур	Max	Unit
Forward Voltage	VF	IF = 60mA	-	3.2	-	V
Uniformity	∆Bp	-	80	-	-	%
Luminance for LCD	Lv	IF = 60 mA		3500	-	cd/m ²

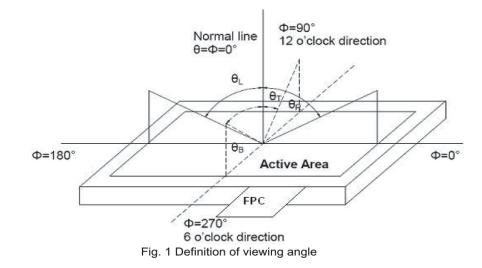
8. Electro-Optical Characteristics

Note 1: Definition of optical measurement system.

The optical characteristics should be measured in dark room. After 5 minutes operation, the optical properties are measured at the center point of the LCD screen. All input terminals LCD panel must be ground when measuring the center area of the panel.



Note 2: Definition of viewing angle range and measurement system. viewing angle is measured at the center point of the LCD by CONOSCOPE(ergo-80).

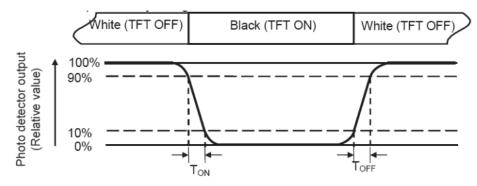


Note 3: Definition of contrast ratio

 $Contrast ratio (CR) = \frac{Luminance measured when LCD is on the "White" state}{Luminance measured when LCD is on the "Black" state}$ "White state ":The state is that the LCD should driven by Vwhite. "Black state": The state is that the LCD should driven by Vblack. V_{White}: To be determined V_{Black}: To be determined.

Note 4: Definition of response time

The response time is defined as the LCD optical switching time interval between "White" state and "Black" state. Rise time (T_{ON}) is the time between photo detector output intensity changed from 90% to 10%. And fall time (T_{OFF}) is the time between photo detector output intensity changed from 10% to 90%.



9. Instruction Description

Command Function	D/CX	BDY	WBX	D17-8	D7	D6	D5	D4	D3	D2	D1	DO	He
No Operation	0	1	1 t	XX	0	0	0	0	0	0	0	0	00
Software Reset	ō	1	Ť	XX	0	0	0	0	ō	0	0	1	01
Solimale Hesel	0	1	+	XX	0	0	0	0	0	1	0	0	04
	1	†	1	XX	X	x	x	x	x	x	X	x	X
Read Display Identification	1	†	1	XX	-	. ^		ID1 [~	^	Ťx
Information	1	t	1	XX				ID2 [Ťx
	1	†	1	XX	-			ID3 [T _x
	0	1	Ť	XX	0	0	0	0	1	0	0	1	0
	1	÷	1	XX	x	x	x	x	x	x	x	x	X
	1	t	1	XX				[31:25]			14	X	0
Read Display Status	1	ŕ	1	XX	x		D [22:20			D [1	9:16]	- 11	6
	1	t	1	XX	X	×	×	x	×		D [10:8]		0
	1	ŕ	1	XX		D [7:5]		x	x	x	X	х	0
	0	1	Ť	XX	0	0	0	0	1	0	1	0	0/
Read Display Power Mode	1	†	1	XX	X	x	x	x	x	x	X	х	X
	1	t	1	XX			D [7	:21			0	0	0
	0	1	†	XX	0	0	0	0	1	0	1	1	OE
Read Display MADCTL	1	t	1	XX	X	X	x	X	x	×	X	х	X
	1	†	1	XX			D [7	:2]			0	0	0
	0	1	t	XX	0	0	0	0	1	1	0	0	00
Read Display Pixel Format	1	Ť	1	XX	X	x	x	х	x	x	х	х	X
	1	t	1	XX	BIM		DPI [2:0	0	X		DBI [2:0]		0
	0	1	1	XX	0	0	0	0	1	1	0	1	10
Read Display Image Format	1	t	1	XX	X	X	X	х	X	X	X	х	X
	1	Ť	1	XX	X	X	x	х	x		D [2:0]		0
	0	1	t	XX	0	0	0	0	1	1	1	0	OE
Read Display Signal Mode	1	Ť	1	XX	X	X	x	х	x	x	х	х	X
	1	t	1	XX	D [7:2] 0			0	0	0			
	0	1	1	XX	0	0	0	0	1	1	1	1	OF
Read Display Self-Diagnostic	1	t	1	XX	X	X	X	X	X	×	X	х	X
Result	1	î	1	XX	D [7	:6]	x	х	х	X	х	х	0
Enter Sleep Mode	0	1	t	XX	0	0	0	1	0	0	0	0	10
Sleep OUT	0	1	1	XX	0	0	0	1	0	0	0	1	11
Partial Mode ON	0	1	t	XX	0	0	0	1	0	0	1	0	12
Normal Display Mode ON	0	1	1	XX	0	0	0	1	0	0	1	1	13
Display Inversion OFF	0	1	t	XX	0	0	1	0	0	0	0	0	20
Display Inversion ON	0	1	1	XX	0	0	1	0	0	0	0	1	21
Gamma Set	0	1	t	XX	0	0	1	0	0	1	1	0	26
Gamma Set	1	1	1	XX		_		GC	7:0]				0
Display OFF	0	1	1	XX	0	0	1	0	1	0	0	0	28
Display ON	0	1	Ť	XX	0	0	1	0	1	0	0	1	25
	0	1	t	XX	0	0	1	0	1	0	1	0	2/
	1	1	1	XX				SC [1	5:8]				X
Column Address Set	1	1	t	XX				SC [X
	1	1	1	XX				EC [1					X
	1	1	Ť	XX				EC [X
	0	1	1	XX	0	0	1	0	1	0	1	1	28
	1	1	Ť	XX				SP [1	5:8]				X
Page Address Set	1	1	1	XX				SP [X
-	1	1	Ť	XX				EP [1					X
	1	1	1	XX				EP [-				X

	0	1	1	XX	0	0	1	0	1	1	0	0	2Cł
Memory Write	1	1	1					0 [17:0]					XX
	0	1	1	XX	0	0	1	0	1	1	0	1	2D
	1	t	1	XX					R	00 [5:0]			XX
	1	Ť	1	XX						nn [5:0]			XX
	1	t	1	XX						31 [5:0]			XX
	1	t	1	XX						00 [5:0]			XX
Color SET	1	t	1	XX						nn [5:0]			XX
	1	t	1	XX					G	64 [5:0]			XX
	1	1	1	XX					В	00 [5:0]			XX
	1	Ť	1	XX					В	nn [5:0]			XX
	1	†.	1	XX						31 [5:0]			XX
	0	1	1	XX	0	0	1	0	1	1	1	0	2E
Memory Read	1	t.	1	XX	Х	Х	х	х	Х	х	х	X	XX
	1	t	1				[[17:0]					XX
	0	1	1	XX	0	0	1	1	0	0	0	0	30
	1	1	1	XX				S	R [15:8]				00
Partial Area	1	1	1	XX				S	R [7:0]				00
	1	1	1	XX				E	R [15:8]				01
	1	1	1	XX				E	R [7:0]		_		ЗF
	0	1	1	XX	0	0	1	1	0	0	1	1	33
	1	1	1	XX				TF	A [15:8]				00
Vertical Scrolling Definition	1	1	1	XX	TFA [7:0]							00	
	1	1	1	XX	VSA [15:8]						01		
	1	1	1	XX	VSA [7:0]						40		
	1	1	1	XX	BFA [15:8]						00		
	1	1	1	XX				B	FA [7:0]				00
Tearing Effect Line OFF	0	1	1	XX	0	0	1	1	0	1	0	0	34
Tearing Effect Line ON	0	1	1	XX	0	0	1	1	0	1	0	1	35
realing crect one on	1	1	1	XX	X	Х	Х	Х	Х	Х	х	M	00
Memory Access Control	0	1	1	XX	0	0	1	1	0	1	1	0	36
Memory Access Control	1	1	1	XX	MY	MX	MV	ML	BGR	MH	X	X	00
	0	1	1	XX	0	0	1	1	0	1	1	1	37
Vertical Scrolling Start Address	1	1	1	XX				VS	P [15:8]				00
	1	1	1	XX				V	SP [7:0]				00
Idle Mode OFF	0	1	1	XX	0	0	1	1	1	0	0	0	38
Idle Mode ON	0	1	1	XX	0	0	1	1	1	0	0	1	39
Pixel Format Set	0	1	1	XX	0	0	1	1	1	0	1	0	зA
Fixer Format Set	1	1	1	XX	X		DPI [2:0	1	Х		DBI [2:0	<u>j</u>	66
Write Memory Continue	0	1	1	XX	0	0	1	1	1	1	0	0	3C
White Memory Contende	1	1	1					[17:0]					XX
	0	1	1	XX	0	0	1	1	1	1	1	0	3E
Read Memory Continue	1	1	1	XX	X	Х	Х	Х	Х	Х	X	X	XX
	1	<u>t</u>	1					[17:0]					x
	0	1	1	XX	0	1	0	0	0	1	0	0	44
Set Tear Scanline	1	1	Ť	XX	X	Х	Х	Х	Х	Х	X	STS [8]	00
	1	1	1	XX				S	TS [7:0]				00
	0	1	1	XX	0	1	0	0	0	1	0	1	45
Get Scanline	1	1	1	XX	X	Х	Х	X	Х	Х	X	X	XX
Sec. Sydimity	1	1	1	XX	X	Х	Х	Х	Х	Х	GT	S [9:8]	00
	1	1	1	XX					TS [7:0]				00
Write Display Brightness	0	1	t	XX	0	1	0	1	0	0	0	1	51ŀ
truce evenuel evidine reag	1	1	1	XX				Df	3V [7:0]				00

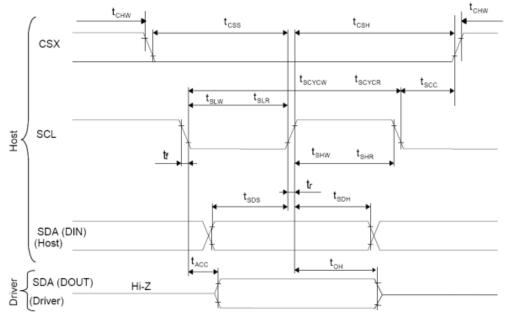
	0	1	↑ (XX	0	1	0	1	0	0	1	0	52h
Read Display Brightness	1	↑	1	XX	X	X	X	X	х	х	Х	Х	XX
	1	↑	1	XX				DBV	[7:0]				00
	0	1	↑ (XX	0	1	0	1	0	0	1	1	53h
Write CTRL Display	1	1		XX	х	х	BCTRL	х	DD	BL	X	х	00
	0	1	↑	XX	0	1	0	1	0	1	0	0	54h
Read CTRL Display	1	↑	1	XX	Х	Х	X	Х	Х	X	X	Х	XX
	1	Î	1	XX	х	х	BCTRL	х	DD	BL	X	Х	00
Write Content Adaptive	0	1	1	XX	0	1	0	1	0	1	0	1	55h
Brightness Control	1	1	Î	XX	Х	Х	Х	х	Х	X	C[1:0]	00
Development Advertise	0	1	1	XX	0	1	0	1	0	1	1	0	56h
Read Content Adaptive Brightness Control	1	Î	1	XX	Х	Х	X	Х	Х	X	X	X	XX
Digitiless Control	1	Î	1	XX	х	х	X	х	х	X	C[1:0]	00
Write CABC Minimum	0	1	↑	XX	0	1	0	1	1	1	1	0	5Eh
Brightness	1	1	↑	XX				CME	[7:0]				00
D. JOADO M. J	0	1	↑	XX	0	1	0	1	0	1	1	1	5Fh
Read CABC Minimum Brightness	1	Î	1	XX	Х	Х	Х	х	Х	X	X	Х	XX
Digitaless	1	1	1	XX				CME	[7:0]				00
	0	1	↑	XX	1	1	0	1	1	0	1	0	DAł
Read ID1	1	1	1	XX	Х	Х	X	Х	Х	X	Х	X	XX
	1	1	1	XX			Modu	ıle's Maı	nufacture	e [7:0]			XX
	0	1	↑	XX	1	1	0	1	1	0	1	1	DBł
Read ID2	1	↑	1	XX	Х	X	Х	X	Х	Х	Х	Х	XX
	1	↑	1	XX			LCD Mo	dule / Di	iver Ver	sion [7:0)]		XX
	0	1	↑	XX	1	1	0	1	1	1	0	0	DCł
Read ID3	1	1	1	XX	Х	X	Х	X	Х	Х	Х	Х	XX
	1	1	1	XX			LCD N	/ Nodule	Driver II	D [7:0]			XX

Extended Command Set													
Command Function	D/CX	RDX	WRX	D17-8	D7	D6	D5	D4	D3	D2	D1	D0	Hex
RGB Interface	0	1	1	XX	1	0	1	1	0	0	0	0	B0h
Signal Control	1	1	1	XX	ByPass_MODE	RCM	[1:0]	Х	VSPL	HSPL	DPL	EPL	40
Frame Central	0	1	Î	XX	1	0	1	1	0	0	0	1	B1h
Frame Control	1	1	Î	XX	X	Х	Х	Х	Х	Х	DIVA	[1:0]	00
(In Normal Mode)	1	1	1	XX	Х	Х	Х		F	TNA [4:0	0]		1B
France Oceation	0	1	1	XX	1	0	1	1	0	0	1	0	B2h
Frame Control	1	1	1	XX	Х	Х	Х	Х	Х	Х	DIVE	[1:0]	00
(In Idle Mode)	1	1	Î	XX	Х	Х	Х		RTNB [4:0]		1B		
France Oceation	0	1	1	XX	1	0	1	1	0	0	1	1	B3h
Frame Control	1	1	1	XX	Х	Х	Х	Х	Х	Х	DIVC	[1:0]	00
(In Partial Mode)	1	1	Î	XX	Х	Х	Х		F	TNC [4:	D]		1B
Disala Investiga Ocatal	0	1	1	XX	1	0	1	1	0	1	0	0	B4h
Display Inversion Control	1	1	Î	XX	Х	Х	Х	Х	Х	NLA	NLB	NLC	02
	0	1	Î	XX	1	0	1	1	0	1	0	1	B5h
	1	1	Î	XX	0				VFP [6:	0]			02
Blanking Porch Control	1	1	Î	XX	0				VBP [6:	0]			02
	1	1	Î	XX	0	0	0			HFP [4:0]		0A
	1	1	Î	XX	0	0	0			HBP [4:0]		14

	0	1	Ť	XX	1	0	1	1	0	1	1	0	B6h
	1	1	1	XX	х	Х	X	Х	PTG	G [1:0]	PT	[1:0]	0A
Display Function Control	1	1	Ť	XX	REV	GS	SS	SM		19	SC [3:0]		82
	1	1	Ť	XX	Х	Х				NL [5:0]			27
	1	1	1	XX	Х	Х			P	CDIV [5:	0]		XX
Entry Mode Set	0	1	Ť	XX	1	0	1	1	0	1	1	1	B7I
2.1.0 / 1.1000 001	1	1	Ť	XX	X	X	X	Х	0	GON	DTE	GAS	07
	0	1		XX	1	0	1	1	1	0	0	0	B8
Backlight Control 1	1	1	1	XX	Х	X	X	Х	Х	X	X	X	XX
	1	1	†.	XX	X	Х	X	X			UI [3:0]		04
	0	1	1	XX	1	0	1	1	1	0	0	1	B9
Backlight Control 2	1	1	Ť	XX	Х	X	X	Х	Х	X	X	X	XX
	1	1	1 1	XX		TH_MV					_ST [3:0]		B8
	0	1	1 1	XX	1	0	1	1	1	0	1	0	BA
Backlight Control 3	1	1	1 1	XX	X	X	X	X	Х	X	X	X	XX
	1	1	†	XX	X	X	X	X			H_UI [3:0]		04
Dealdlakt Original 4	0	1	1 1	XX	1	0	1	1	1	0	1	1	BB
Backlight Control 4	1	1	1	XX	X	X	X	Х	X	X	X	X	XX
	1	1	1	XX		DTH_M		4			H_ST [3:0]	0	C9
Dealdiabt Control 5	0	1	1	XX	1	0	1	1	1	1	0	0	BC
Backlight Control 5	1	1	↑ ↑	XX	X	X	X	Х	X	X	X	X (1	XX
	1	1	T ↑	XX	4	DIM2	3:0]	1	X 1		DIM1 [2:		44
Backlight Control 7	0	1	1 †	XX XX	1	0	1		DIV [7	1	1	0	BEI 0F
	0	1	+	XX	1	0	1	1	1	1	1	1	BFI
Backlight Control 8	1	1	1	XX	X	x	X	x	x				00
	0	1	†	XX	1	1	0	0	0	0	0	LEDPWMOPL 0	CO
Power Control 1	1	1	†	XX	X	X		0	-	/RH [5:0]		0	26
	0	1	Ť	XX	1	1	0	0	0	0	0	1	C1
Power Control 2	1	1	†	XX	X	x	X	X	x		BT [2:		00
	0	1	†	XX	1	1	0	0	0	1	0	1	C5
VCOM Control 1	1	1	Ť	XX	x	<u> </u>			VMH				31
	1	1	†	XX	X				VML				30
	0	1	†	XX	1	1	0	0	0	1	1	1	C7
VCOM Control 2	1	1	Ť	XX	nVM				VMF	[6:0]			CO
	0	1	†	XX	1	1	0	1	0	0	0	0	DO
NV Memory Write	1	1	Ť	XX	X	X	X	X	X	P	GM_ADR		00
	1	1	Ť	XX				PGM	DATA [XX
	0	1	Ť	XX	1	1	0	1	0	0	0	1	D1
	1	1	Ť	XX				KE	/ [23:16				55
NV Memory Protection Key	1	1	Ť	XX					Y [15:8]				AA
	1	1	Ť	XX					Y [7:0]				66
	0	1	Ť	XX	1	1	0	1	0	0	1	0	D2
	1	1	1	XX	X	Х	Х	Х	Х	Х	х	х	XX
NV Memory Status Read	1	t	1	XX	X		CNT		X		D1_CNT		XX
	1	t	1	XX	BUSY		E_CNT		Х		D3_CNT		XX

	0	•	1	XX	1	1	0	1	0	0	1	1	D3h
	1	H.	1	XX	x	x	x	x	x	x	x	X	XX
Read ID4	1	+	1	XX	0	0	0	0	0	0	0	0	00
neau ib4	1		1	XX	1	0	0	1	0	0	1	1	93
	1	l +	1	XX	0	1	0	0	0	0	0	1	41
	0	1	†	XX	1	1	1	0	0	0	0	0	E0h
	1	1	†	XX	x	X	x	x	0	-	0 [3:0]	0	08
	1	1	↑	XX	x	X			VP1 [5		0 [3:0]		08 0E
	1	1		XX	x	X							12
	1	1			x	X	x	x	VP2 [5		4 [3:0]		05
	1	1	T t	XX XX	x	X	x	-	L	P6 [4			03
					x	X	x	- v	v (
Desitive Commo	1	1	1	XX		~	~	X	200 (0.0)	VP	3 [3:0]		09
Positive Gamma	1	1	1 1	XX	X	VDool	0.01	V	P20 [6:0]	VD	7 10.01		47
Correction	1	1	↑ ·	XX	~	VP36	[3:0]		240.00.01	VP2	27 [3:0]		86
	1	1	↑	XX	X		~		P43 [6:0]		0 10 01		2B
	1	1	↑	XX	X	X	X	X			50 [3:0]		0B
	1	1	<u>↑</u>	XX	X	X	X		VE	P57 [4			04
	1	1	<u>t</u>	XX	X	X	X	X			59 [3:0]		00
	1	1	L T	XX	X	X			VP61 [5				00
	1	1	<u> </u>	XX	X	X			VP62 [5				00
	1	1	L T	XX	X	Х	X	X			53 [3:0]		00
	0	1	Γ.	XX	1	1	1	0	0	0	0	1	E1h
	1	1	↑	XX	X	Х	Х	X			0 [3:0]		08
	1	1	L Ť	XX	X	Х			VN1 [5	-			1A
	1	1	1	XX	X	Х			VN2 [5				20
	1	1	↑	XX	X	Х	X	X			4 [3:0]		07
	1	1	L T	XX	X	Х	Х		V	N6 [4	-		0E
	1	1	<u>۲</u>	XX	X	X	X	X		VN1	3 [3:0]		05
Negative Gamma	1	1	↑	XX	X			VI	120 [6:0]				3A
Correction	1	1	1	XX		VN36	[3:0]			VN2	27 [3:0]		8A
	1	1	1	XX	X				V43 [6:0]				40
	1	1	L Ť	XX	X	Х	X	X		VN	50 [3:0]		04
	1	1	L Ť	XX	X	Х	Х		V	157 [4	1:0]		18
	1	1	1	XX	X	Х	Х	X			59 [3:0]		0F
	1	1	L T	XX	X	Х			VN61 [5:0]			3F
	1	1	L Ť	XX	X	Х			VN62 [5:0]			3F
	1	1	1 t	XX	X	Х	Х	X		VNe	53 [3:0]		0F
Digital Gamma Control 1	0	1	L Ť	XX	1	1	1	0	0	0	1	0	E2h
1 st Parameter	1	1	1 t	XX		RCA0				BC/	A0 [3:0]		XX
:	1	1	1	XX		RCAx	[3:0]			BC/	Ax [3:0]		XX
16 th Parameter	1	1	1	XX		RCA15				BCA	15 [3:0		XX
Digital Gamma Control 2	0	1	t	XX	1	1	1	0	0	0	1	1	E3h
1 st Parameter	1	1	t	XX		RFA0	[3:0]			BFA	A0 [3:0]		XX
:	1	1	1	XX		RFAx					Ax [3:0]		XX
64 th Parameter	1	1	t	ХХ		RFA63					63 [3:0]		XX
	0	1	T t	XX	1	1	1	1	0	1	1	0	F6h
	1	1	T T	XX	MY_EOR	MX_EOR	MV_EOR	X	BGR_EOR	X	X	WEMODE	01
Interface Control	1	1	T T	XX	X	X	EPF [X	X		T [1:0]	00
	1	1	l †	XX	X	X	ENDIAN	X	DM [1:		RM	RIM	00

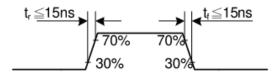
10. AC Characteristics

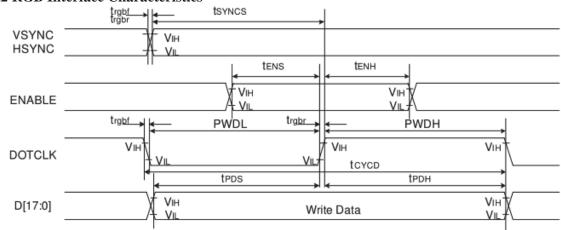


10.1 Serial data Transfer Interface Characteristics

Signal	Symbol	Parameter	min	max	Unit	Description
	tscycw	Serial Clock Cycle (Write)	100	-	ns	
	tshw	SCL "H" Pulse Width (Write)	40	-	ns	
SCL	tslw	SCL "L" Pulse Width (Write)	40	-	ns	
SUL	tscycr	Serial Clock Cycle (Read)	150	-	ns	
	tshr	SCL "H" Pulse Width (Read)	60	-	ns	
	tslr	SCL "L" Pulse Width (Read)	60	-	ns	
SDA / SDI	tsds	Data setup time (Write)	30	-	ns	
(Input)	tsdh	Data hold time (Write)	30	-	ns	
SDA / SDO	tacc	Access time (Read)	10	-	ns	
(Output)	toh	Output disable time (Read)	10	50	ns	
	tscc	SCL-CSX	20	-	ns	
csx	tchw	CSX "H" Pulse Width	40	-	ns	
054	tcss	CSX-SCL Time	60	-	ns	
	tcsh	CSX-SUL TIME	65	-	ns	

Note: Ta = 25 °C, VDDI=1.65V to 3.3V, VCI=2.5V to 3.3V, AGND=VSS=0V

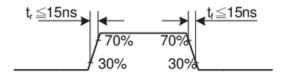




10.2 RGB Interface Characteristics

Signal	Symbol	Parameter	min	max	Unit	Description
VSYNC /	tsyncs	VSYNC/HSYNC setup time	15	-	ns	
HSYNC	t SYNCH	VSYNC/HSYNC hold time	15	-	ns	
DE	t _{ENS}	DE setup time	15	-	ns]
	t _{ENH}	DE hold time	15	-	ns	
D[17:0]	tPOS	Data setup time	15	-	ns	18/16-bit bus RGB
D[17.0]	t _{PDH}	Data hold time	15	-	ns	interface mode
	PWDH	DOTCLK high-level period	15	-	ns	
DOTCLK	PWDL	DOTCLK low-level period	15	-	ns	
DOTOLK	tcycp	DOTCLK cycle time	100	-	ns	
	t _{rgbr} , t _{rgbf}	DOTCLK, HSYNC, VSYNC rise/fall time	-	15	ns	
VSYNC /	tsyncs	VSYNC/HSYNC setup time	15	-	ns	
HSYNC	t SYNCH	VSYNC/HSYNC hold time	15	-	ns	
DE	t _{ENS}	DE setup time	15	-	ns	
DE	tenn	DE hold time	15	-	ns	
D[17:0]	tPOS	Data setup time	15	-	ns	6-bit bus RGB
D[17.0]	t _{PDH}	Data hold time	15	-	ns	interface mode
	PWDH	DOTCLK high-level pulse period	15	-	ns	
DOTCLK	PWDL	DOTCLK low-level pulse period	15	-	ns	
DOTOLK	tcycp	DOTCLK cycle time	100	-	ns]
	t _{rgbr} , t _{rgbf}	DOTCLK,HSYNC,VSYNC rise/fall time	-	15	ns	

Note: Ta = -30 to 70 °C, VDDI=1.65V to 3.3V, VCI=2.5V to 3.3V, AGND=VSS=0V



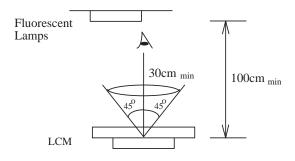
11.Quality Specifications

All The raw material are Rohs complicant.

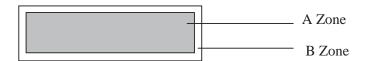
11.1 Standard of the product appearance test

Manner of appearance test: The inspection should be performed in using 20W x 2 fluorescent lamps. Distance between LCM and fluorescent lamps should be 100 cm or more. Distance between LCM and inspector eyes should be 30 cm or more.

Viewing direction for inspection is 45° from vertical against LCM.



Definition of zone:



A Zone: viewing area B Zone: outside viewing area

11.2 Specification of quality assurance

AQL inspection standard

Sampling method: MIL-STD-105E, Level II, single sampling

Classify		Item	Note	AQL
Major	Display state	Short or open circuit		0.65
		LC leakage		
		Flickering	1	
		No display		
		Wrong viewing direction		
		Contrast defect (dim, ghost)	2	
		Back-light	1,8	
	Non-display	Flat cable or pin reverse	10	
		Wrong or missing component	11	
Minor	Display state	Background color deviation	2	1.0
		Black spot and dust	3	
		Line defect, Scratch	4	
		Rainbow	5	
		Chip	6	
		Pin hole	7	
	Polarizer	Protruded	12	
		Bubble and foreign material	3	
	Soldering	Poor connection	9	
	Wire	Poor connection	10	
	TAB	Position, Bonding strength	13	

Defect classification (Note: * is not including)

Note on defect classification

No.	Item			(Criterion		
1	Short or open circuit			N	Not allow		
	LC leakage						
	Flickering						
	No display						
	Wrong viewing direction						
	Wrong Back-light						
2	Contrast defect		Refe	r to	approval sam	ple	
	Background color deviation						
3	Point defect, Black spot, dust (including Polarizer)	∏ X			Point Size ¢≤0.10	Acceptable Qty. Disregard	
	(more and g i of an inter)	~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~	-	0	<u>φ≤0.10</u> 10<φ≤0.20	3	
			_		10<φ <0.20 20<φ≤0.25	2	
	$\phi = (X+Y)/2$		_		25<¢≤0.30	1	
					φ>0.30	0	
			Unit	t: r	mm		
4	Line defect,						
	Scratch]	Line	Acceptable Qty.	
				(W 0.015≥W	Disregard	
		L	3.0≥		0.03≥W		
			2.0≥	L	0.05≥W	2	
			1.0≥	L	0.1>W	1	
			 [Unit	0.05 <w< td=""><td>Applied as point defe</td><td><u></u></td></w<>	Applied as point defe	<u></u>
5	Rainbow	Not more than tw	o color	· cha	anges across t	he viewing area.	

No	Item	Criterion
6	Chip Remark: X: Length direction	X X Y X X X X X X X X Z X X X Z
	Y: Short direction Z: Thickness direction t: Glass thickness W: Terminal Width	$\begin{array}{c c} X & Y \\ \hline \\ X & Y \\ \hline \\ Z \\ \end{array} \\ \begin{array}{c} X & Y \\ \hline \\ \hline \\ Z \\ \end{array} \\ \begin{array}{c} X & Y \\ \hline \\ \hline \\ \hline \\ Z \\ \end{array} \\ \begin{array}{c} X & Y \\ \hline \\ \hline \\ \hline \\ \hline \\ Z \\ \end{array} \\ \begin{array}{c} X & Y \\ \hline \\ \hline \\ \hline \\ \hline \\ \hline \\ Z \\ \end{array} \\ \begin{array}{c} X & Y \\ \hline \\$
		$\begin{array}{c c} X & Y & Z \\ \hline X & X &$
		$W_{y} \qquad \qquad$
		$\begin{array}{c c} & Y \\ & & \\ \hline & & \\ & \\ & \\ & \\ & \\ & \\ & \\$

No.	Item	Criterion
7	Segment pattern W = Segment width $\phi = (X+Y)/2$	(1) Pin hole $\phi < 0.10$ mm is acceptable. X Point Size Acceptable Qty
		$\begin{array}{c c c c c c c c c c c c c c c c c c c $
8	Back-light	 The color of backlight should correspond its specification. Not allow flickering
9	Soldering	 (1) Not allow heavy dirty and solder ball on PCB. (The size of dirty refer to point and dust defect) (2) Over 50% of lead should be soldered on Land.
10	Wire	 (1) Copper wire should not be rusted (2) Not allow crack on copper wire connection. (3) Not allow reversing the position of the flat cable. (4) Not allow exposed copper wire inside the flat cable.
11*	РСВ	(1) Not allow screw rust or damage.(2) Not allow missing or wrong putting of component.

No	Item	Criterion
12	Protruded W: Terminal Width	W_{y} Acceptable criteria: $Y \le 0.4$
13	ТАВ	1. Position $H \xrightarrow{W} W_{1} \xrightarrow{W} W_{1} \xrightarrow{W_{1} \leq 1/3W} H_{1} \leq 1/3H}$ 2 FPC bonding strength test $F \xrightarrow{F} FPC$
		P (=F/FPC bonding width) ≥650gf/cm ,(speed rate: 1mm/min) 5pcs per SOA (shipment)
14	Total no. of acceptable Defect	 A. Zone Maximum 2 minor non-conformities per one unit. Defect distance: each point to be separated over 10mm B. Zone It is acceptable when it is no trouble for quality and assembly in customer's end product.

11.3 Reliability of LCM

Reliability test condition:

Item	Condition	Time (hrs)	Assessment
High temp. Storage	60°C	48	
High temp. Operating	50°C	48	
Low temp. Storage	-10°C	48	No abnormalities
Low temp. Operating	0°C	48	in functions
Humidity	60°C/90%RH	48	and appearance
Temp. Cycle	$-10^{\circ}C \leftarrow 25^{\circ}C \rightarrow 60^{\circ}C$	10cycles	
	$(60 \min \leftarrow 5 \min \rightarrow 60 \min)$		

Recovery time should be 24 hours minimum. Moreover, functions, performance and appearance shall be free from remarkable deterioration within 50,000 hours under ordinary operating and storage conditions room temperature ($20\pm8^{\circ}C$), normal humidity (below 65% RH), and in the area not exposed to direct sun light.

11.4 Precaution for using LCD/LCM

LCD/LCM is assembled and adjusted with a high degree of precision. Do not attempt to make any alteration or modification. The followings should be noted.

General Precautions:

- 1. LCD panel is made of glass. Avoid excessive mechanical shock or applying strong pressure onto the surface of display area.
- 2. The polarizer used on the display surface is easily scratched and damaged. Extreme care should be taken when handling. To clean dust or dirt off the display surface, wipe gently with cotton, or other soft material soaked with isoproply alcohol, ethyl alcohol or trichlorotriflorothane, do not use water, ketone or aromatics and never scrub hard.
- 3. Do not tamper in any way with the tabs on the metal frame.
- 4. Do not made any modification on the PCB without consulting Regal Honour.
- 5. When mounting a LCM, make sure that the PCB is not under any stress such as bending or twisting. Elastomer contacts are very delicate and missing pixels could result from slight dislocation of any of the elements.
- 6. Avoid pressing on the metal bezel, otherwise the elastomer connector could be deformed and lose contact, resulting in missing pixels and also cause rainbow on the display.
- 7. Be careful not to touch or swallow liquid crystal that might leak from a damaged cell. Any liquid crystal adheres to skin or clothes, wash it off immediately with soap and water.

Static Electricity Precautions:

- 1. CMOS-LSI is used for the module circuit; therefore operators should be grounded whenever he/she comes into contact with the module.
- 2. Do not touch any of the conductive parts such as the LSI pads; the copper leads on the PCB and the interface terminals with any parts of the human body.
- 3. Do not touch the connection terminals of the display with bare hand; it will cause disconnection or defective insulation of terminals.
- 4. The modules should be kept in anti-static bags or other containers resistant to static for storage.
- 5. Only properly grounded soldering irons should be used.
- 6. If an electric screwdriver is used, it should be grounded and shielded to prevent sparks.
- 7. The normal static prevention measures should be observed for work clothes and working benches.
- 8. Since dry air is inductive to static, a relative humidity of 50-60% is recommended.

Soldering Precautions:

- 1. Soldering should be performed only on the I/O terminals.
- 2. Use soldering irons with proper grounding and no leakage.
- 3. Soldering temperature: $280^{\circ}C \pm 10^{\circ}C$
- 4. Soldering time: 3 to 4 second.
- 5. Use eutectic solder with resin flux filling.
- 6. If flux is used, the LCD surface should be protected to avoid spattering flux.
- 7. Flux residue should be removed.

Operation Precautions:

- 1. The viewing angle can be adjusted by varying the LCD driving voltage Vo.
- 2. Since applied DC voltage causes electro-chemical reactions, which deteriorate the display, the applied pulse waveform should be a symmetric waveform such that no DC component remains. Be sure to use the specified operating voltage.
- 3. Driving voltage should be kept within specified range; excess voltage will shorten display life.
- 4. Response time increases with decrease in temperature.
- 5. Display color may be affected at temperatures above its operational range.
- 6. Keep the temperature within the specified range usage and storage. Excessive temperature and humidity could cause polarization degradation, polarizer peel-off or generate bubbles.
- 7. For long-term storage over 40°C is required, the relative humidity should be kept below 60%, and avoid direct sunlight.

Limited Warranty

Regal Honour LCDs and modules are not consumer products, but may be incorporated by Regal Honour's customers into consumer products or components thereof, Regal Honour does not warrant that its LCDs and components are fit for any such particular purpose.

- 1. The liability of Regal Honour is limited to repair or replacement on the terms set forth below. Regal Honour will not be responsible for any subsequent or consequential events or injury or damage to any personnel or user including third party personnel and/or user. Unless otherwise agreed in writing between Regal Honour and the customer, Regal Honour will only replace or repair any of its LCD which is found defective electrically or visually when inspected in accordance with Regal Honour general LCD inspection standard. (Copies available on request)
- 2. No warranty can be granted if any of the precautions state in handling liquid crystal display above has been disregarded. Broken glass, scratches on polarizer mechanical damages as well as defects that are caused accelerated environment tests are excluded from warranty.
- 3. In returning the LCD/LCM, they must be properly packaged; there should be detailed description of the failures or defect.